

PLEASE CHECK WWW.MOLEX.COM FOR LATEST PART INFORMATION

Part Number: [0754921022](#)
Status: **Active**
Overview: [gbx_backplane_connector_system](#)
Description: 1.85mm by 1.85mm (.073 by .073") Pitch 2-Pair GbX® Backplane Connector System, Power Module, 4 Circuits, 1.27µm (50µ") Gold (Au), Lead Free

Documents:
[Drawing \(PDF\)](#) [RoHS Certificate of Compliance \(PDF\)](#)
[Product Specification PS-75221-999 \(PDF\)](#)

Agency Certification

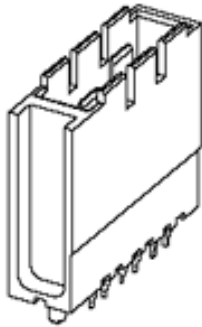
UL E29179

General

Product Family Backplane Connectors
Series [75492](#)
Application Backplane
Application Tooling Documents Tooling Manual
Comments Blade Length A 4.50mm, B 4.50mm
Component Type Power Header
Overview [gbx_backplane_connector_system](#)
Product Name GbX®
Style N/A

Physical

Circuits (Loaded) 4
Circuits (maximum) 4
Circuits Detail Rows A & B
Color - Resin Gray (Dark)
Durability (mating cycles max) 200
First Mate / Last Break No
Flammability 94V-0
Guide to Mating Part No
Keying to Mating Part None
Material - Metal High Performance Alloy (HPA)
Material - Plating Mating Gold
Material - Plating Termination Tin
Material - Resin High Temperature Thermoplastic
Number of Columns N/A
Number of Pairs 2
Number of Rows 2
Orientation Vertical
PC Tail Length (in) 0.090 In
PC Tail Length (mm) 2.28 mm
PCB Locator Yes
PCB Retention Yes
PCB Thickness Recommended (in) 0.063 In
PCB Thickness Recommended (mm) 1.60 mm
Packaging Type Tube
Pitch - Mating Interface (in) 0.730 In
Pitch - Mating Interface (mm) 1.85 mm
Pitch - Term. Interface (in) 0.102 In
Pitch - Term. Interface (mm) 2.60 mm
Plating min: Mating (µin) 50
Plating min: Mating (µm) 1.25



*Series
image - Reference only*

EU RoHS
ELV and RoHS
Compliant
REACH SVHC
Contains SVHC: No
Halogen-Free
Status
Halogen-Free

China RoHS



**Need more information on product
environmental compliance?**

Email productcompliance@molex.com
For a multiple part number RoHS Certificate of
Compliance, [click here](#)

Please visit the [Contact Us](#) section for any
non-product compliance questions.

Search Parts in this Series
[75492Series](#)

Mates With
[75292 GbX® Daughtercard](#)

Plating min: Termination (μin)	30
Plating min: Termination (μm)	0.75
Polarized to PCB	Yes
Stackable	No
Surface Mount Compatible (SMC)	Yes
Temperature Range - Operating	105°C
Termination Interface: Style	Through Hole - Compliant Pin

Electrical

Current - Maximum per Contact	6A
Data Rate	8.0 Gbps
Shielded	No
Voltage - Maximum	120V AC (RMS)/DC

Material Info

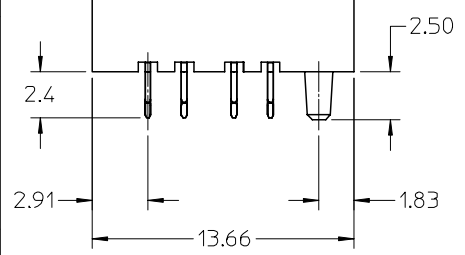
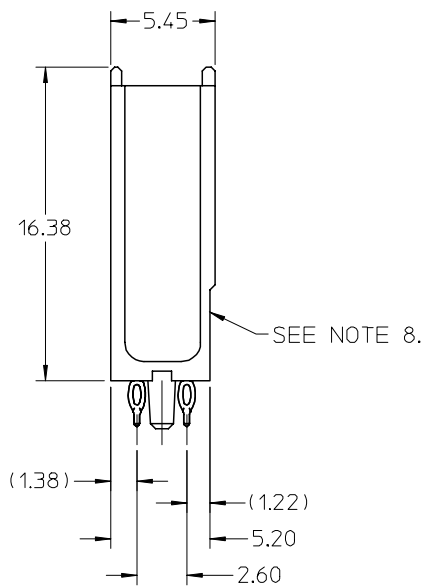
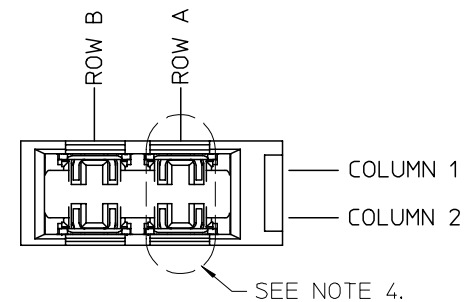
Reference - Drawing Numbers

Packaging Specification	PK-70873-578
Product Specification	PS-75221-999
Sales Drawing	SD-75492-001

GbX is a registered trademark of Amphenol Corporation.

This document was generated on 05/25/2010
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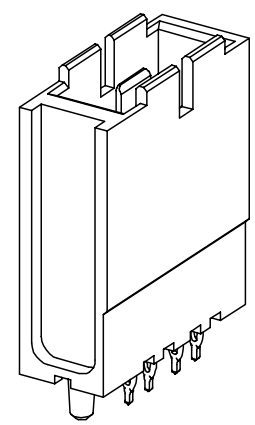
10 9 8 7 6 5 4 3 2 1



1-UP ASSEMBLY PART NUMBER

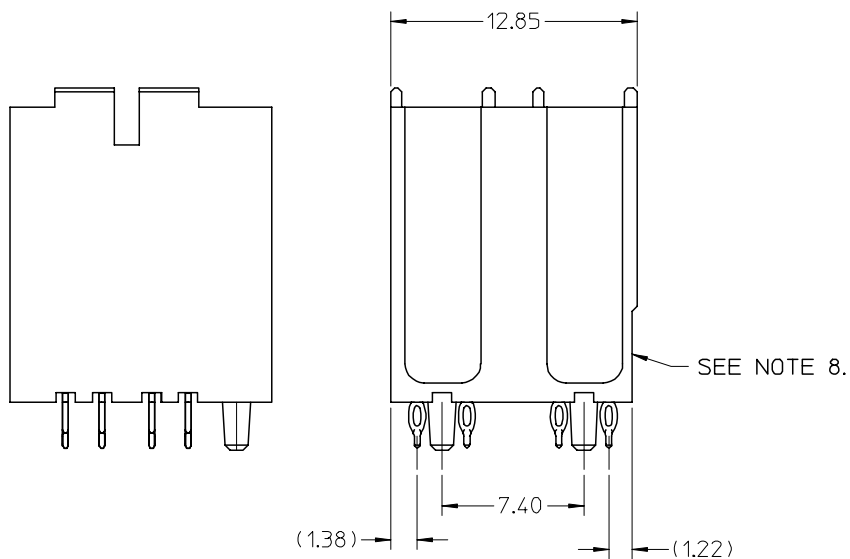
- 7 5 4 9 2 - 1 0 A B
- TIN/LEAD PLATED PRODUCT -
FOR EACH ROW LOCATION A, B:
4 = 4.5 mm
6 = 6.0 mm
7 = 7.5 mm
- LEAD-FREE PLATED PRODUCT -
FOR EACH ROW LOCATION A, B:
2 = 4.5 mm
3 = 6.0 mm
5 = 7.5 mm

- NOTES:
1. MATERIALS: HOUSING - LIQUID CRYSTAL POLYMER (LCP), UL 94V-0, GRAY; CONTACT - COPPER ALLOY
 2. FINISH: SELECT GOLD IN CONTACT AREA, 50 μ THICK; TIN/LEAD OR MATTE TIN IN COMPLIANT AREA.
 3. PACKAGING PER PK-70873-578.
 4. CONTACTS IN EACH ROW HAVE THE SAME WIPE LENGTH.
 5. BACKPLANE ASSEMBLY MATES WITH DAUGHTERCARD POWER MODULE 75292-2***.
 6. PART SHOWN IS 75492-1067.
 7. SEE OTHER SHEETS FOR ADDITIONAL NOTES.
 8. WHEN INSERTING OPEN SIGNAL MODULES NEXT TO COLUMN 1 SIDE OF POWER MODULES, SIGNAL MODULES MUST BE INSERTED BEFORE THE POWERS TO AVOID INTERFERENCE BETWEEN THE TWO CONNECTOR HOUSINGS.
 9. THESE PARTS CONFORM TO MOLEX PRODUCT SPECIFICATION PS-75221-999.
 10. THESE PARTS CONFORM TO MOLEX COSMETIC SPECIFICATION PS-45499-002 CLASS B.



SEE SHEET 4 FOR HOLE PATTERN LAYOUT

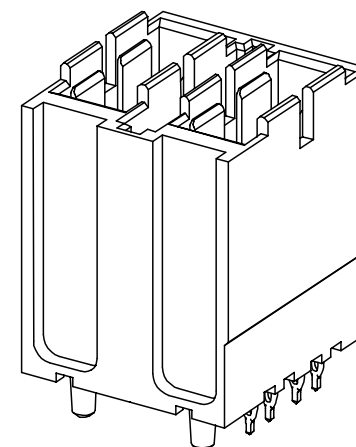
ADDED NOTES 9 & 10 EC NO: UCP2008-0426 DRAWN: STEWART 2007/08/29 CHKD: J. BINGHAM 2007/08/30 APPR: J. BINGHAM 2007/08/31	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 4:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION		
			mm	INCH	DRAWN BY	DATE	GBX 2 PAIR BACKPLANE POWER SALES ASSEMBLY			
		4 PLACES	± ---	± ---	ELO	2005/07/01				
		3 PLACES	± ---	± ---	CHECKED BY	DATE				
		2 PLACES	± ---	± ---	ELO	2005/07/01	MOLEX INCORPORATED			
		1 PLACE	± ---	± ---	APPROVED BY	DATE				
		ANGULAR ± 5 °			BIXLER	2005/07/06	SD-75492-001			
		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS			MATERIAL NO.	DOCUMENT NO.				
								SIZE B	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION	



7 5 4 9 2 - 2 0 A B

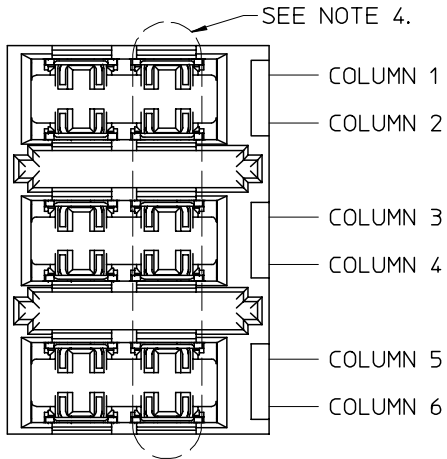
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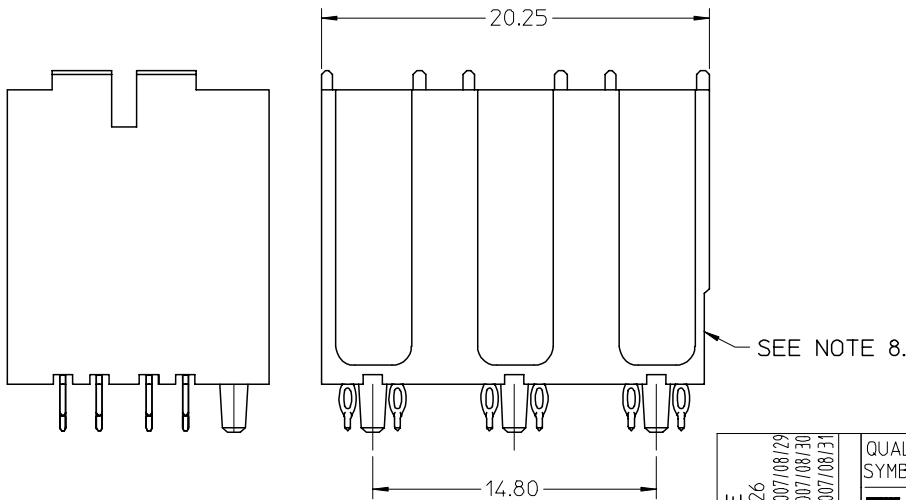
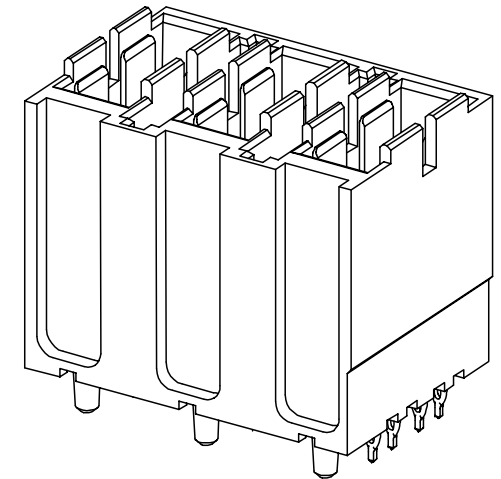
SEE SHEET 1 FOR ADDITIONAL INFORMATION
CHECK WITH PRODUCT MANAGER FOR AVAILABILITY

SEE SHEET ONE EC NO: UCP2008-0426 DRAWN: STEWART 2007/08/29 CHK'D: BINGHAM 2007/08/30 APPR: BINGHAM 2007/08/31	DESCRIPTION REV	QUALITY SYMBOLS ▽=0 ▽=0	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 4:1	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION			
				mm	INCH	DRAWN BY	DATE	TITLE GBX 2 PAIR BACKPLANE POWER SALES ASSEMBLY				
			4 PLACES	± ---	± ---	ELO	2005/07/01					
			3 PLACES	± ---	± ---	CHECKED BY	DATE	MOLEX INCORPORATED				
			2 PLACES	± ---	± ---	ELO	2005/07/01					
			1 PLACE	± ---	± ---	APPROVED BY	DATE	SD-75492-001				
			ANGULAR ± 5 °			BIXLER	2005/07/06					
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS				SEE CHART		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION						



3-UP ASSEMBLY PART NUMBER

- 7 5 4 9 2 - 3 0 A B
- TIN/LEAD PLATED PRODUCT -
FOR EACH ROW LOCATION A, B:
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6 = 6.0 mm
7 = 7.5 mm
 - LEAD-FREE PLATED PRODUCT -
FOR EACH ROW LOCATION A, B:
2 = 4.5 mm
3 = 6.0 mm
5 = 7.5 mm



SEE SHEET 1 FOR ADDITIONAL INFORMATION
CHECK WITH PRODUCT MANAGER FOR AVAILABILITY

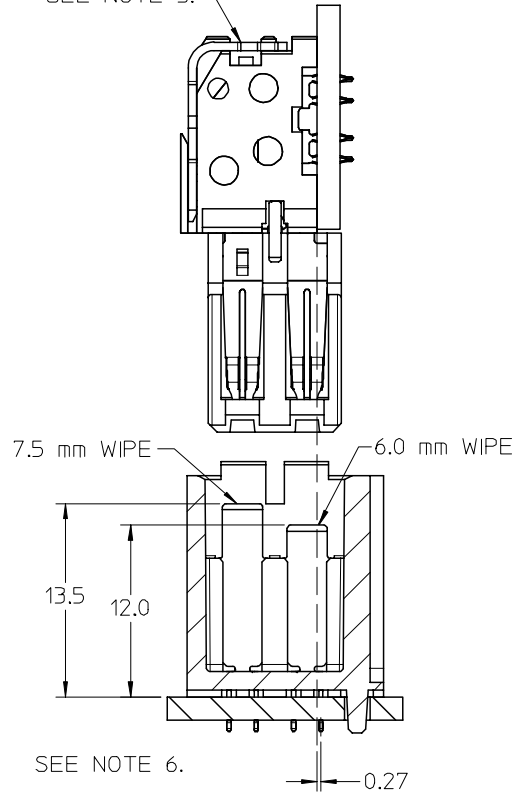
SEE SHEET ONE EC NO: UCP2008-0426 DRAWN: STEWART 2007/08/29 CHKD: BINGHAM 2007/08/30 APPR: BINGHAM 2007/08/31	QUALITY SYMBOLS ▽=0 ▽=0	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE 4:1	DESIGN UNITS METRIC	 THIRD ANGLE PROJECTION	
			mm	INCH	DRAWN BY ELO	DATE 2005/07/01	GBX 2 PAIR BACKPLANE POWER SALES ASSEMBLY MOLEX INCORPORATED			
			4 PLACES ± --- ± ---	CHECKED BY	DATE					
			3 PLACES ± --- ± ---	ELO	2005/07/01					
			2 PLACES ± --- ± ---	APPROVED BY	DATE					
1 PLACE ± --- ± ---	BIXLER	2005/07/06	MOLEX							
REV		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS	ANGULAR ± 5 °		MATERIAL NO.		DOCUMENT NO.		SHEET NO.	
			SEE CHART		SD-75492-001		3 OF 4			
			THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION							

10 9 8 7 6 5 4 3 2 1

HOLE PATTERN FOR 1-UP ASSEMBLY

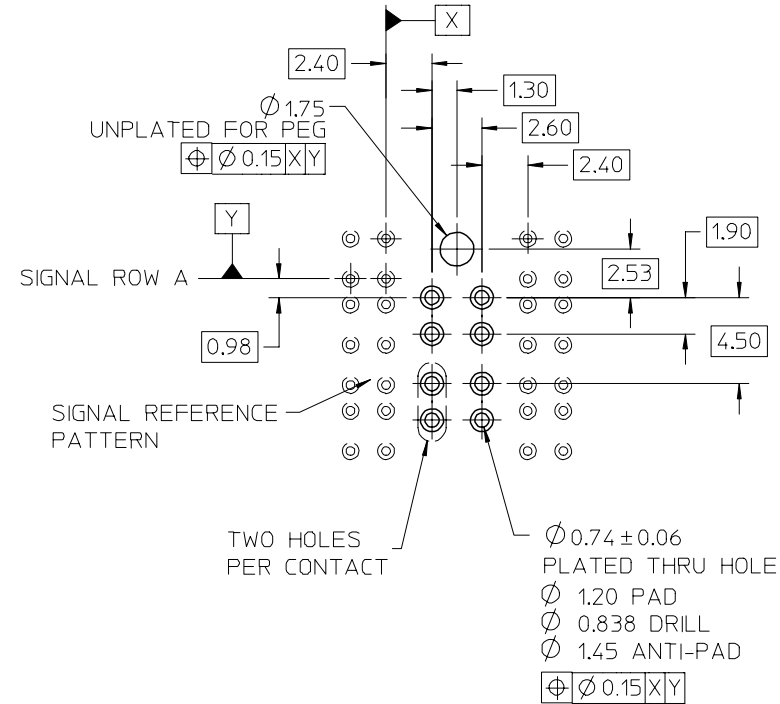
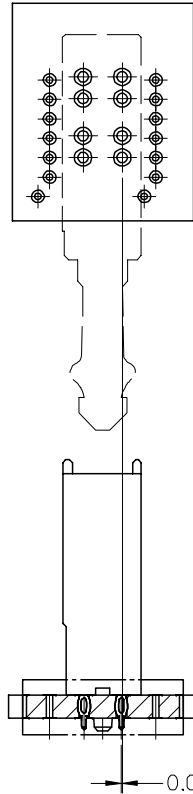
- 1.) ADD 7.40 FROM CENTERLINES OF PEG FOR MULTIPLE UP ASSEMBLIES
- 2.) USE 5.55 FROM CENTERLINE TO CENTERLINE OF PEG FOR INDIVIDUAL POWER MODULES STACKED NEXT TO EACH OTHER.

SEE NOTE 5.



SEE NOTE 6.

0.27
DC BOARD EDGE TO
CENTERLINE OF BP TAIL



SEE SHEET ONE
EC NO: UCP2008-0426
DRAWN: STEWART 2007/08/29
CHKD: BINGHAM 2007/08/30
APPR: BINGHAM 2007/08/31

QUALITY
SYMBOLS
=0
=0

	GENERAL TOLERANCES (UNLESS SPECIFIED)	
	mm	INCH
4 PLACES	± ---	± ---
3 PLACES	± ---	± ---
2 PLACES	± ---	± ---
1 PLACE	± ---	± ---
ANGULAR ± 5 °		
DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		

DIMENSION STYLE MM ONLY	
DRAWN BY	DATE
ELO	2005/07/01
CHECKED BY	DATE
ELO	2005/07/01
APPROVED BY	DATE
BIXLER	2005/07/06
MATERIAL NO.	
SEE PREVIOUS	
SIZE	
B	

SCALE 4:1	DESIGN UNITS METRIC	 THIRD ANGLE PROJECTION
TITLE GBX 2 PAIR BACKPLANE POWER SALES ASSEMBLY		
6  MOLEX INCORPORATED		
DOCUMENT NO. SD-75492-001		SHEET NO. 4 OF 4
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9 8 7 6 5 4 3 2 1

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<http://moschip.ru/get-element>

Вы можете разместить у нас заказ для любого Вашего проекта, будь то серийное производство или разработка единичного прибора.

В нашем ассортименте представлены ведущие мировые производители активных и пассивных электронных компонентов.

Нашей специализацией является поставка электронной компонентной базы двойного назначения, продукции таких производителей как XILINX, Intel (ex.ALTERA), Vicor, Microchip, Texas Instruments, Analog Devices, Mini-Circuits, Amphenol, Glenair.

Сотрудничество с глобальными дистрибьюторами электронных компонентов, предоставляет возможность заказывать и получать с международных складов практически любой перечень компонентов в оптимальные для Вас сроки.

На всех этапах разработки и производства наши партнеры могут получить квалифицированную поддержку опытных инженеров.

Система менеджмента качества компании отвечает требованиям в соответствии с ГОСТ Р ИСО 9001, ГОСТ РВ 0015-002 и ЭС РД 009

Офис по работе с юридическими лицами:

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